

L Number	Hits	Search Text	DB	Time stamp
5	0	(fusible adj filler) and (alloy with (melting adj point))	USPAT; US-PGPUB	2004/08/30 15:40
6	0	(fusible adj filler) and (alloy with (melting adj point))	USPAT; US-PGPUB	2004/08/30 15:40
7	11	(fusible adj (metal or alloy)) and (alloy same (melting adj point))	USPAT; US-PGPUB	2004/08/30 16:13
8	11	US-5062896-\$.DID. OR US-4869954-\$.DID. OR US-4914551-\$.DID. OR US-4612601-\$.DID. OR US-4606962-\$.DID. OR US-6365973-\$.DID. OR US-0634013-\$.DID. OR US-6059952-\$.DID. OR US-6114413-\$.DID. OR US-6365973-\$.DID. OR US-6207300-\$.DID. OR US-5213715-\$.DID.	USPAT; US-PGPUB	2004/08/30 16:14
-	36415	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:34
-	1	((thermal adj interface) or (phase adj change)) and (filler near fusible)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/18 18:25
-	1	(thermal adj interface) and (phase adj change adj polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:44
-	93	(phase adj change) near polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:28
-	2	((phase adj change) near polymer) and (thermal adj interface)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:28
-	55	(thermal adj interface) and (phase adj change) and filler	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:45
-	2	(thermal adj interface) and (phase adj change) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:13
-	44	(thermal adj interface adj material) and (phase adj change) and filler	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/27 18:47
-	20	(lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:14
-	37657	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/27 15:20

-	2	((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:18
-	6	((lead or cadmium or mercury or antimony or arsenic) and (fusible near filler)) and phase	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:19
-	20	(lead or cadmium or mercury, antimony or arsenic) and (fusible near filler)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/01 16:28
-	37735	(thermal adj interface) or (phase adj change)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:34
-	315	Jayaraman.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	2306	Konig.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	237	Dani.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	2852	Jayaraman.IN. or Konig.IN. or Dani.IN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:35
-	10	(Jayaraman.IN. or Konig.IN. or Dani.IN.) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:41
-	3304	(428/323).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	583	(428/673).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	2201	(428/402).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37
-	296	(428/645).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:37

-	1220	(524/432).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38
-	1519	(524/495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38
-	1224	(524/437).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:38
-	9951	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 10:39
-	87	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)) and ((thermal adj interface) or (phase adj change))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:41
-	23	((428/323).CCLS.) or ((428/673).CCLS.) or ((428/402).CCLS.) or ((428/645).CCLS.) or ((524/432).CCLS.) or ((524/495).CCLS.) or ((524/437).CCLS.)) and ((thermal adj interface) or (phase adj change)) and (fusible or melted)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/02 11:42
-	11302	alloy with(melting adj point)	USPAT; US-PGPUB	2004/03/04 15:24
-	0	(fusible adj filler) and (alloy with(melting adj point))	USPAT; US-PGPUB	2004/08/30 15:40
-	627	fusible and (alloy with(melting adj point))	USPAT; US-PGPUB	2004/08/27 15:19
-	4	fusible and (alloy with(melting adj point)) and filler and composition and (thermal adj interface)	USPAT; US-PGPUB	2004/03/04 15:26
-	56	(thermal adj interface) and (phase adj change) and solder and (fiber or nitride or oxide or graphite)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/27 15:22